

APPLICATION DATA SHEET

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Title of Invention	STACKED SEMICONDUCTOR PACKAGES AND METHOD FOR THE FABRICATION THEREOF		
Application Type: regular, utility Attorney Docket Number: 27-008			
Correspondence address: Customer Number: 22898 *22898*			
Continuing Data: This is a Non-Provisional of US application number 60/442,569, filed 2003-01-23.			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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